NEC

MOS FIELD EFFECT TRANSISTOR
μPA622TT

N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

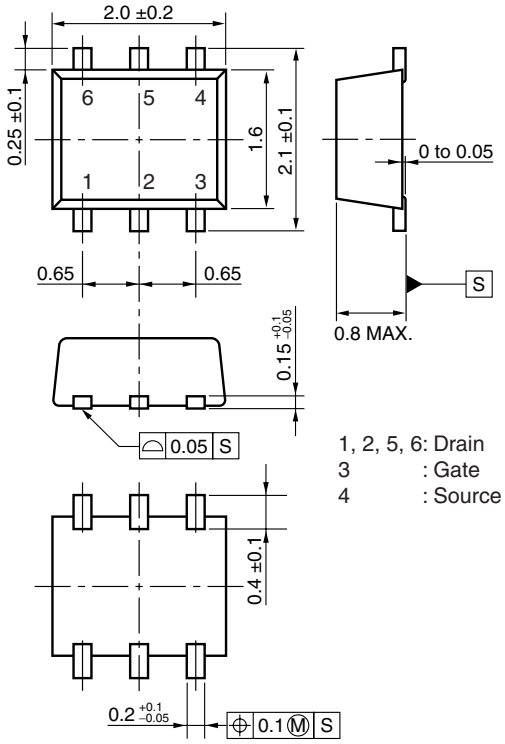
The μPA622TT is a switching device which can be driven directly by a 4.0 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- 4.0 V drive available
- Low on-state resistance
  $R_{DS(on)1}$ = 82 mΩ MAX. (V_{GS} = 10 V, I_D = 1.5 A)
  $R_{DS(on)2}$ = 120 mΩ MAX. (V_{GS} = 4.5 V, I_D = 1.0 A)
  $R_{DS(on)3}$ = 139 mΩ MAX. (V_{GS} = 4.0 V, I_D = 1.0 A)

PACKAGE DRAWING (Unit: mm)



★ ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA622TT-E1-A	6 pin WSOF (1620)
μPA622TT-E2-A	

Remark "-A" indicates Pb-free (This product does not contain Pb in external electrode and other parts.).
"-E1" or "-E2" indicates the unit orientation.
(8 mm embossed carrier tape, 3000 pcs/reel)

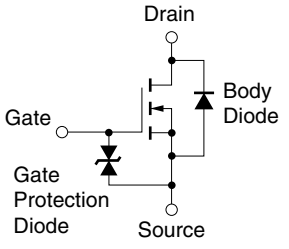
Marking: WC

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Drain to Source Voltage (V_{GS} = 0 V)	V_{DSS}	30	V
Gate to Source Voltage (V_{DS} = 0 V)	V_{GSS}	±20	V
Drain Current (DC) Note1	$I_{D(DC)}$	±3.0	A
Drain Current (pulse) Note2	$I_{D(pulse)}$	±12	A
Total Power Dissipation	P_{T1}	0.2	W
Total Power Dissipation Note1	P_{T2}	1.3	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature	T_{stg}	–55 to +150	°C

Notes 1. Mounted on FR-4 board of 5000 mm² x 1.1 mm, t ≤ 5 sec.
2. PW ≤ 10 μs, Duty Cycle ≤ 1%

EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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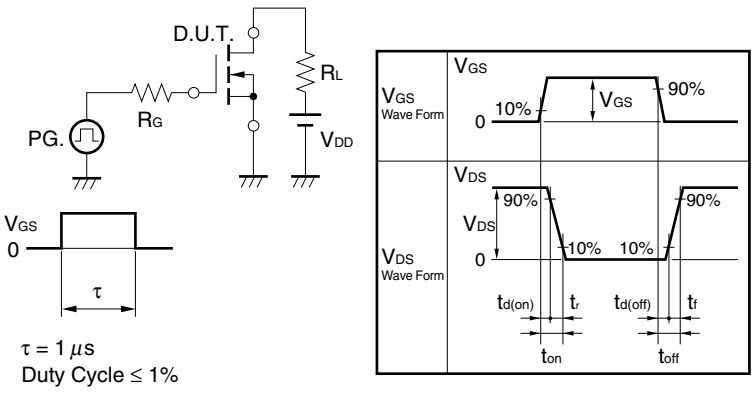
The mark ★ shows major revised points.

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

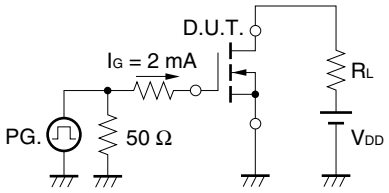
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 30 V, V_{GS} = 0 V			10	μA
★ Gate Leakage Current	I_{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V			±10	μA
Gate Cut-off Voltage	$V_{GS(off)}$	V_{DS} = 10 V, I_D = 1.0 mA	1.5	2.0	2.5	V
Forward Transfer Admittance Note	$\|y_{fs}\|$	V_{DS} = 10 V, I_D = 1.5 A	0.5	2.1		S
Drain to Source On-state Resistance Note	$R_{DS(on)1}$	V_{GS} = 10 V, I_D = 1.5 A		65	82	mΩ
	$R_{DS(on)2}$	V_{GS} = 4.5 V, I_D = 1.0 A		90	120	mΩ
	$R_{DS(on)3}$	V_{GS} = 4.0 V, I_D = 1.0 A		104	139	mΩ
Input Capacitance	C_{iss}	V_{DS} = 10 V		155		pF
Output Capacitance	C_{oss}	V_{GS} = 0 V		45		pF
Reverse Transfer Capacitance	C_{rss}	f = 1.0 MHz		27		pF
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = 15 V, I_D = 1.5 A		10		ns
Rise Time	t_r	V_{GS} = 10 V		28		ns
Turn-off Delay Time	$t_{d(off)}$	R_G = 10 Ω		75		ns
Fall Time	t_f			50		ns
Total Gate Charge	Q_G	V_{DD} = 24 V		3.8		nC
Gate to Source Charge	Q_{GS}	V_{GS} = 10 V		0.7		nC
Gate to Drain Charge	Q_{GD}	I_D = 3.0 A		1.3		nC
Body Diode Forward Voltage Note	$V_{F(S-D)}$	I_F = 3.0 A, V_{GS} = 0 V		0.90		V

Note Pulsed

TEST CIRCUIT 1 SWITCHING TIME

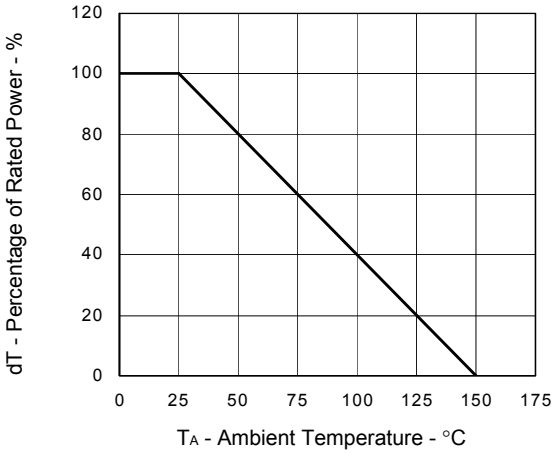


TEST CIRCUIT 2 GATE CHARGE

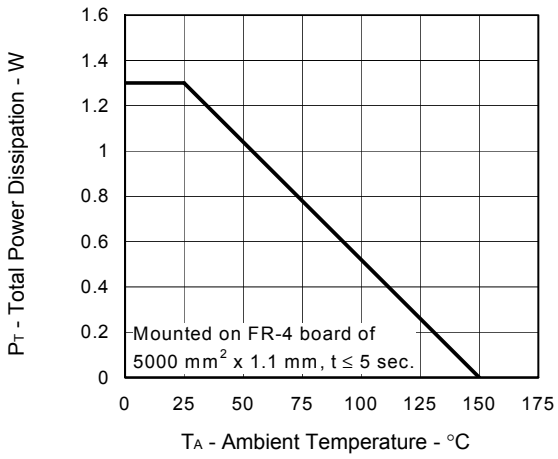


TYPICAL CHARACTERISTICS (T_A = 25°C)

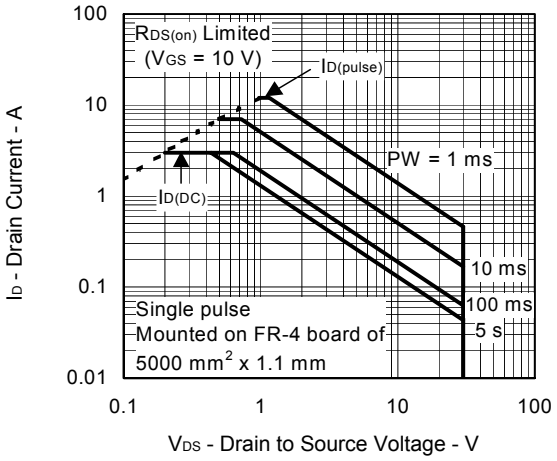
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



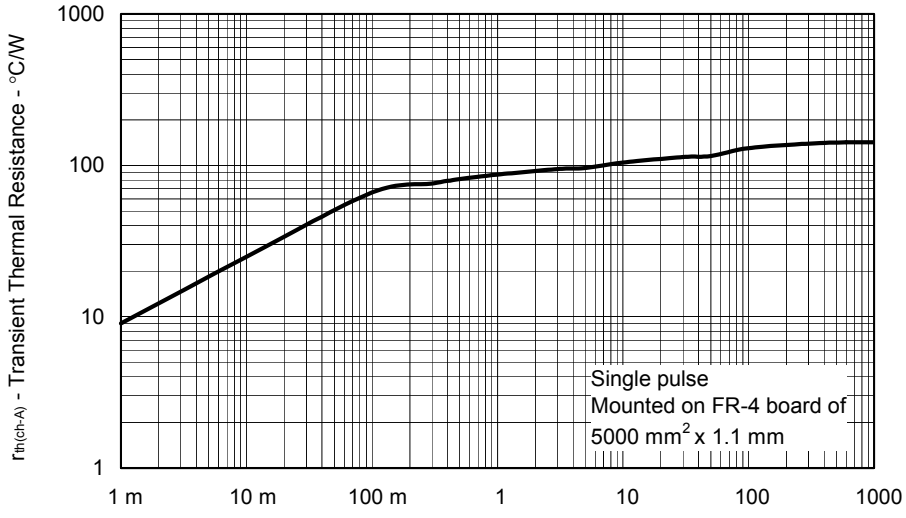
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



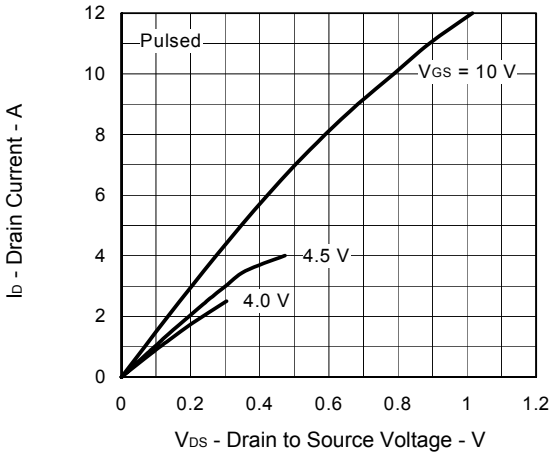
FORWARD BIAS SAFE OPERATING AREA



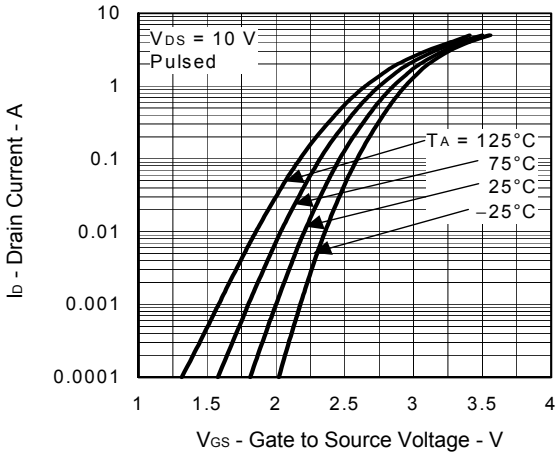
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



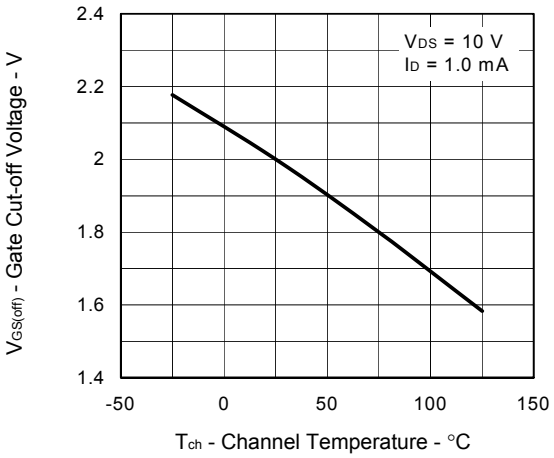
DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE



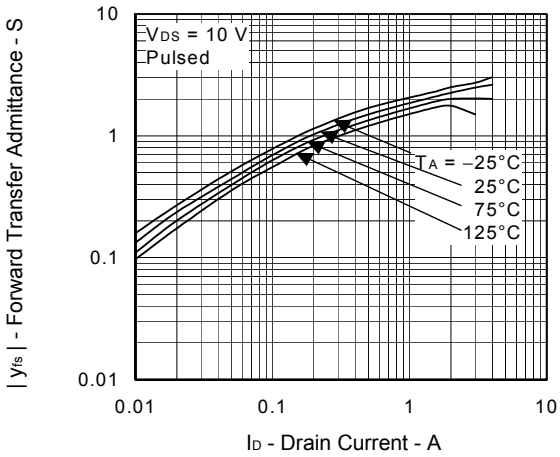
FORWARD TRANSFER CHARACTERISTICS



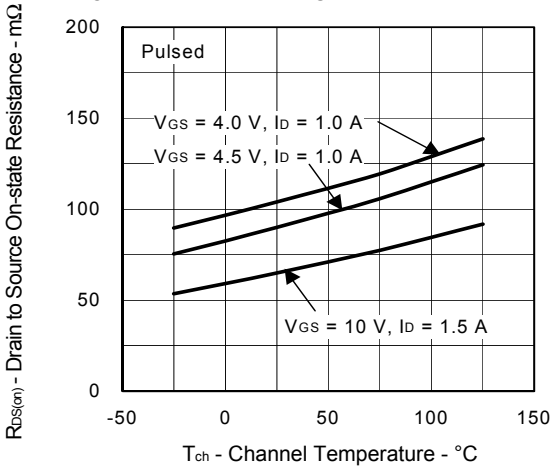
GATE CUT-OFF VOLTAGE vs.
CHANNEL TEMPERATURE



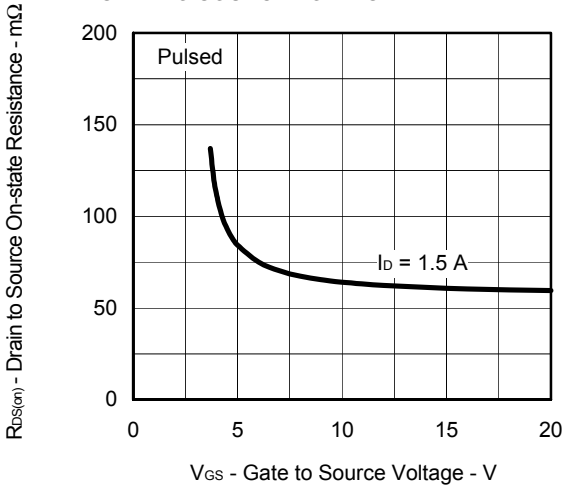
FORWARD TRANSFER ADMITTANCE vs.
DRAIN CURRENT



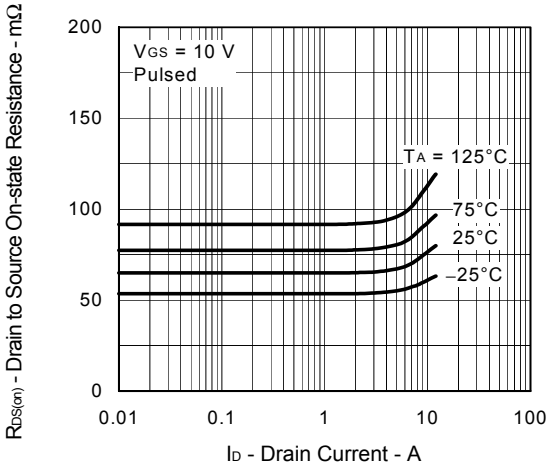
DRAIN TO SOURCE ON-STATE RESISTANCE vs.
CHANNEL TEMPERATURE



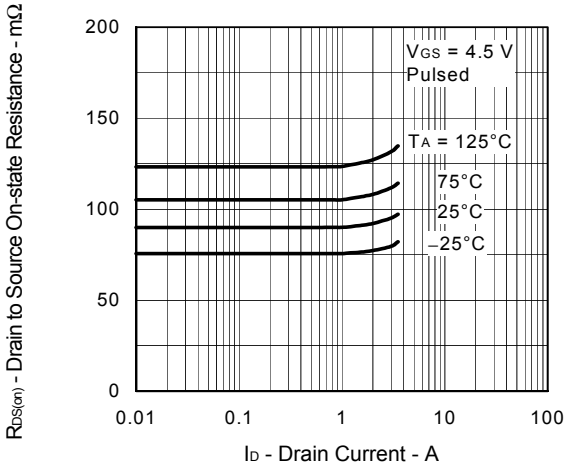
DRAIN TO SOURCE ON-STATE RESISTANCE vs.
GATE TO SOURCE VOLTAGE



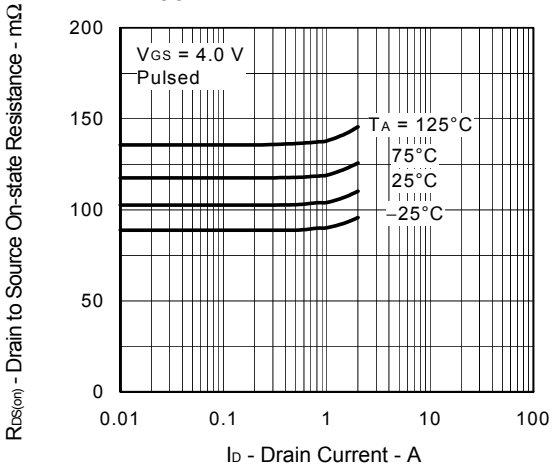
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



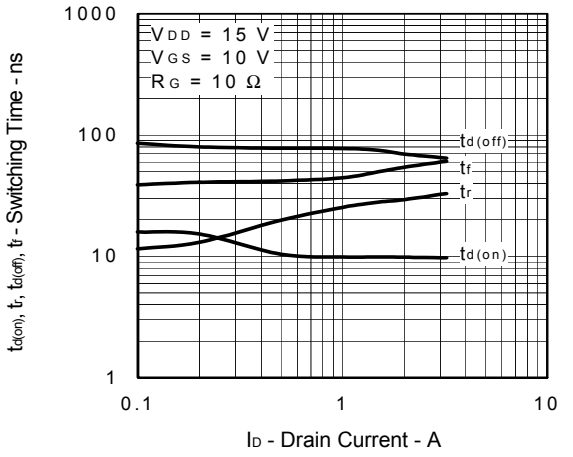
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



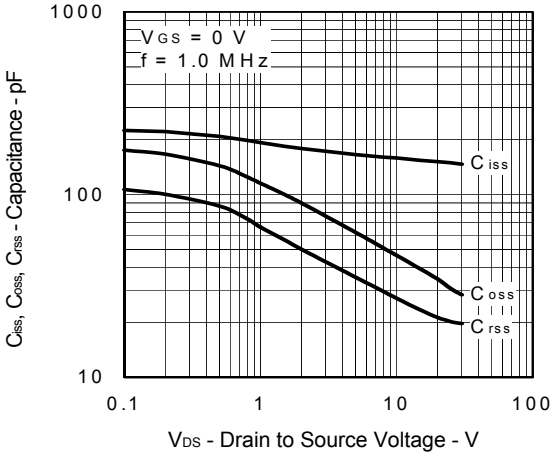
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



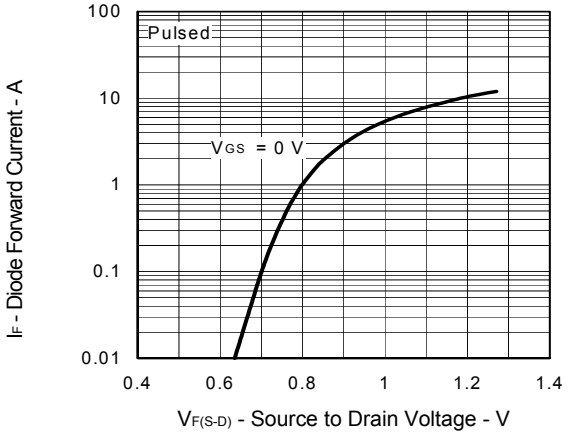
SWITCHING CHARACTERISTICS



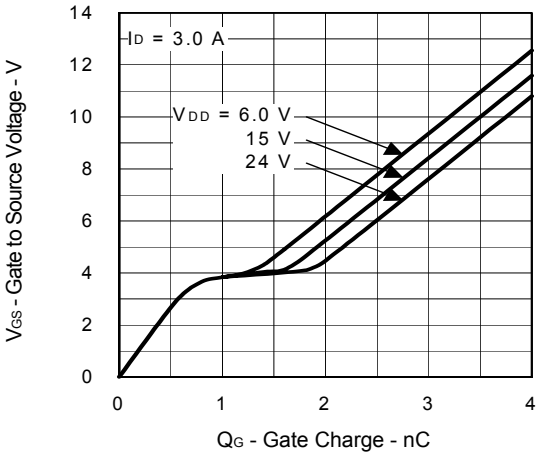
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



DYNAMIC INPUT/OUTPUT CHARACTERISTICS



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